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December 2001

FDG330P

FAIRCHILD

P-Channel 1.8V Specified PowerTrench[®] MOSFET

General Description

This P-Channel 1.8V specified MOSFET uses Fairchild's advanced low voltage PowerTrench process. It has been optimized for battery power management applications.

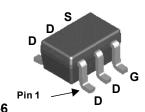
Applications

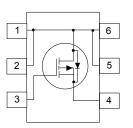
- Battery management
- Load switch

Features

• –2 A, –12 V.

- Low gate charge
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- Compact industry standard SC70-6 surface mount package





SC70-6

Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-12	V
V _{GSS}	Gate-Source Voltage		± 8	V
ID	Drain Current – Continuous	(Note 1a)	-2	А
	- Pulsed		-6	
PD	Power Dissipation for Single Operation	(Note 1a)	0.75	W
		(Note 1b)	0.48	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		–55 to +150	°C

Thermal Characteristics

$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	Note 1b)	260	°C/W
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Package Marking and Ordering Information

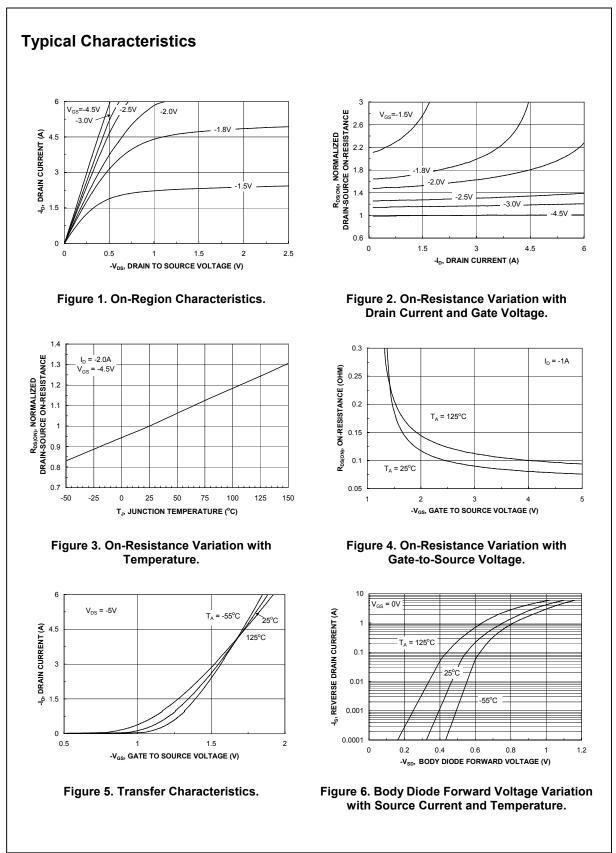
Device Marking	Device	Reel Size	Tape width	Quantity
.30	FDG330P	7"	8mm	3000 units

FDG330P

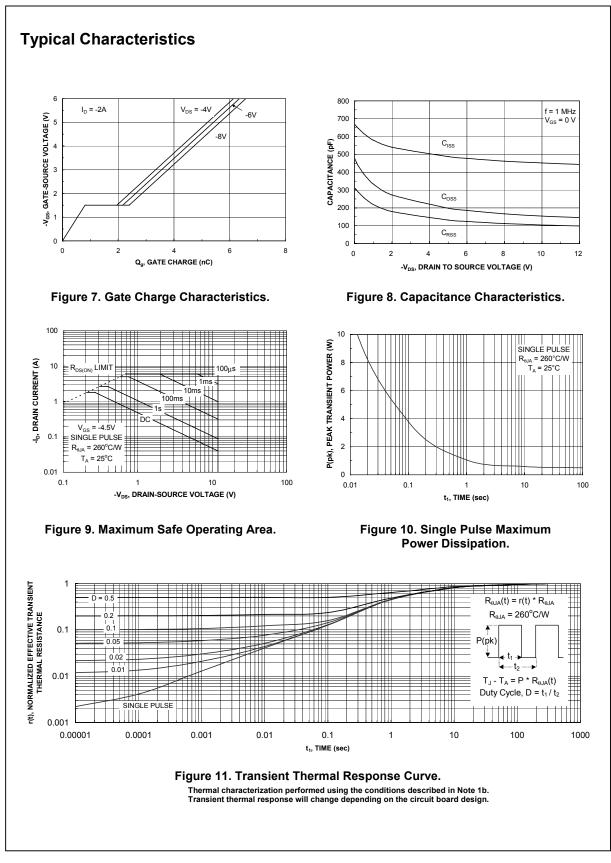
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chai	racteristics	-				
3V _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = -250 \mu A$	-12			V
<u>∆BVdss</u> ∆Tj	Breakdown Voltage Temperature Coefficient	I_D = -250 µA, Referenced to 25°C		-2.7		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -10 V$, $V_{GS} = 0 V$			-1	μA
GSSF	Gate–Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -8 V$, $V_{DS} = 0 V$			-100	nA
On Char	racteristics (Note 2)					
/ _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = -250 \ \mu A$	-0.4	-0.7	-1.5	V
ΔV _{GS(th)} ΔT _J	Gate Threshold Voltage Temperature Coefficient	I_D = -250 µA, Referenced to 25°C		2.3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$V_{GS} = -4.5 V, I_D = -2.0 A$ $V_{GS} = -2.5 V, I_D = -1.7 A$ $V_{GS} = -1.8 V, I_D = -1.4 A$ $V_{GS} = -4.5 V, I_D = -2.0 A T_I = 125^{\circ}C$		84 107 145 98	110 150 215 148	mΩ
D(on)	On-State Drain Current	$V_{GS} = -4.5 \text{ V}, I_D = -2.0 \text{ A}, T_J = 125^{\circ}\text{C}$ $V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$	-6			А
FS	Forward Transconductance	$V_{DS} = -5 V$, $I_{D} = -2.0 A$		6.8		S
Dvnamio	c Characteristics				1	
liss	Input Capacitance	$V_{DS} = -6.0 V$, $V_{GS} = 0 V$,		477		pF
Soss	Output Capacitance	f = 1.0 MHz		186		pF
Srss	Reverse Transfer Capacitance			124		pF
Switchir	ng Characteristics (Note 2)					
d(on)	Turn–On Delay Time	$V_{DD} = -6.0 V$, $I_D = 1 A$,		10	20	ns
	Turn–On Rise Time	V_{GS} = -4.5 V, R_{GEN} = 6 Ω		11	20	ns
d(off)	Turn–Off Delay Time			12	22	ns
t j	Turn–Off Fall Time			18	32	ns
ζ _g	Total Gate Charge	$V_{DS} = -6.0 \text{ V}, I_D = -2.0 \text{ A},$		5	7	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = -4.5 V$		0.8		nC
	Gate–Drain Charge			1.4		nC
	•	and Maximum Ratings				
⊋ _{gd}	ource Diode Characteristics				1	•
⊋ _{gd}	ource Diode Characteristics				-0.62	А

b.) 260°C/W when mounted on a minimum pad.

2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%



FDG330P



FDG330P

FDG330P Rev D (W)

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